

2MBI200N-060

IGBT Module

600V / 200A 2 in one-package

Features

- High speed switching
- Voltage drive
- Low inductance module structure

Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

Maximum ratings and characteristics

Absolute maximum ratings (at $T_c=25^{\circ}\text{C}$ unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V_{CES}	600	V
Gate-Emitter voltage	V_{GES}	± 20	V
Collector current	Continuous	200	A
	1ms	I_c pulse	400
	Continuous	- I_c	200
	1ms	- I_c pulse	400
Max. power dissipation	P_c	780	W
Operating temperature	T_j	$+150$	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-40 to $+125$	$^{\circ}\text{C}$
Isolation voltage	V_{is}	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *1	3.5	N·m

*1 : Recommendable value : 2.5 to 3.5 N·m(M5)

Electrical characteristics (at $T_j=25^{\circ}\text{C}$ unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I_{CES}	—	—	2.0	$V_{GE}=0\text{V}$, $V_{CE}=600\text{V}$	mA
Gate-Emitter leakage current	I_{GES}	—	—	30	$V_{CE}=0\text{V}$, $V_{GE}=\pm 20\text{V}$	μA
Gate-Emitter threshold voltage	$V_{GE(th)}$	4.5	—	7.5	$V_{CE}=20\text{V}$, $I_c=200\text{mA}$	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	—	—	2.8	$V_{GE}=15\text{V}$, $I_c=200\text{A}$	V
Input capacitance	C_{ies}	—	13200	—	$V_{GE}=0\text{V}$	pF
Output capacitance	C_{oes}	—	2930	—	$V_{CE}=10\text{V}$	pF
Reverse transfer capacitance	C_{res}	—	1330	—	$f=1\text{MHz}$	pF
Turn-on time	t_{on}	—	0.6	1.2	$V_{CC}=300\text{V}$	μs
	t_r	—	0.2	0.6	$I_c=200\text{A}$	
Turn-off time	t_{off}	—	0.6	1.0	$V_{GE}=\pm 15\text{V}$	μs
	t_f	—	0.2	0.35	$R_G=9.1\text{ ohm}$	
Diode forward on voltage	V_F	—	—	3.0	$I_F=200\text{A}$, $V_{GE}=0\text{V}$	V
Reverse recovery time	t_{rr}	—	—	0.3	$I_F=200\text{A}$	μs

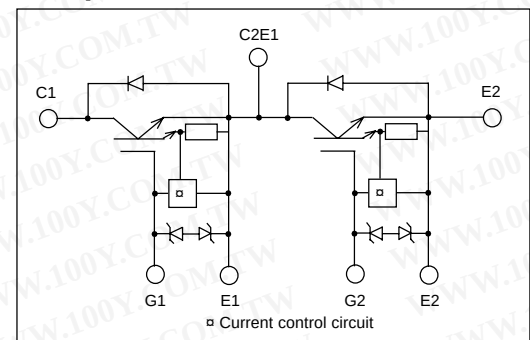
Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	$R_{th(j-c)}$	—	—	0.16	IGBT	$^{\circ}\text{C/W}$
	$R_{th(j-c)}$	—	—	0.35	Diode	$^{\circ}\text{C/W}$
	$R_{th(c-f)*2}$	—	0.025	—	the base to cooling fin	$^{\circ}\text{C/W}$

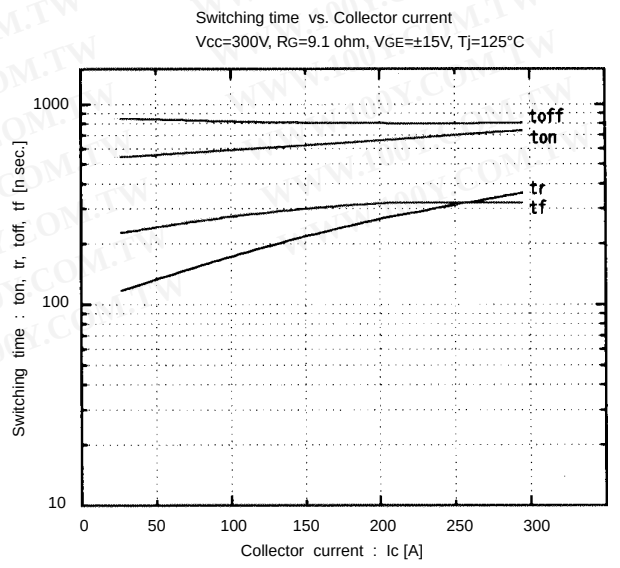
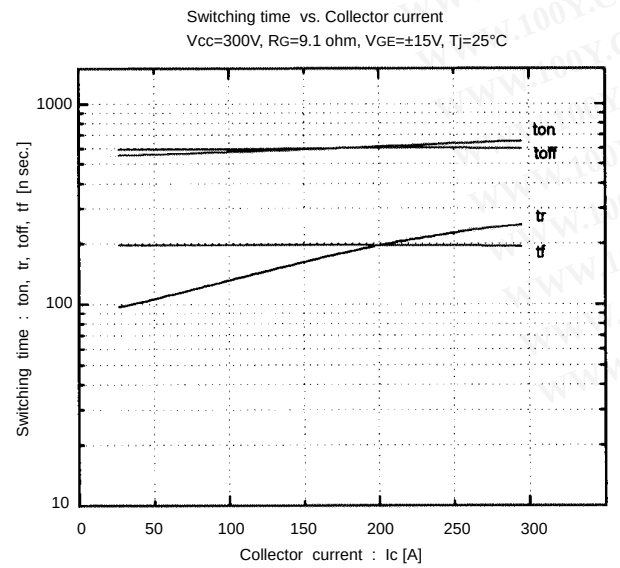
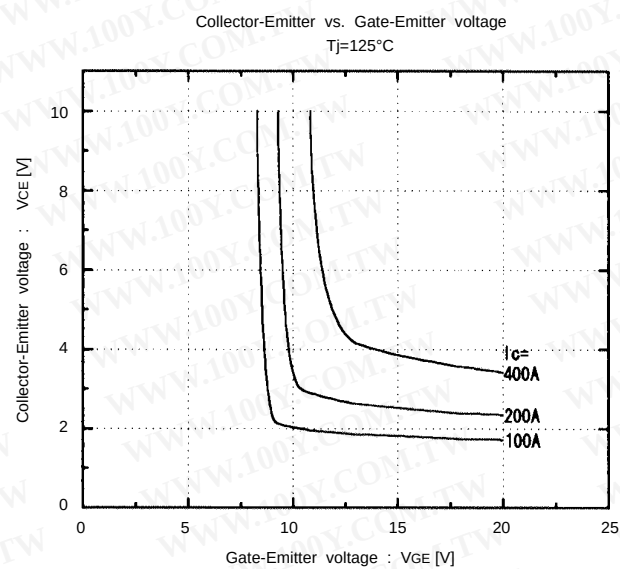
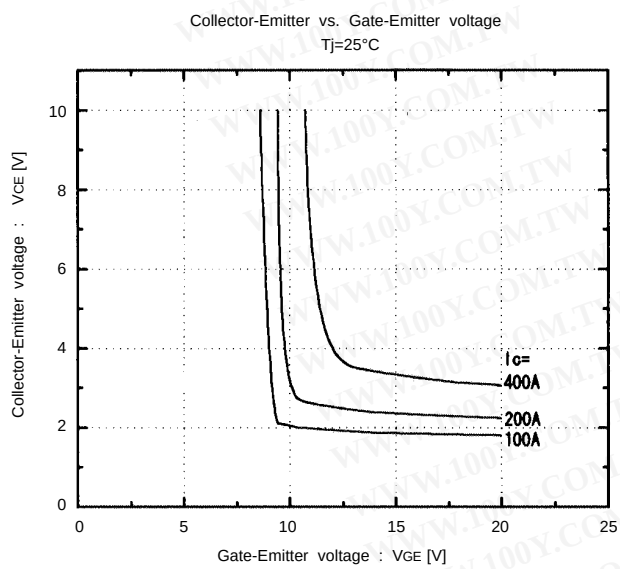
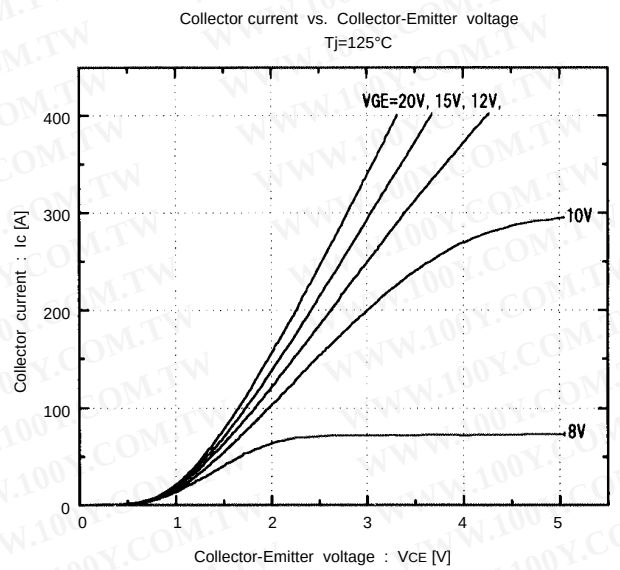
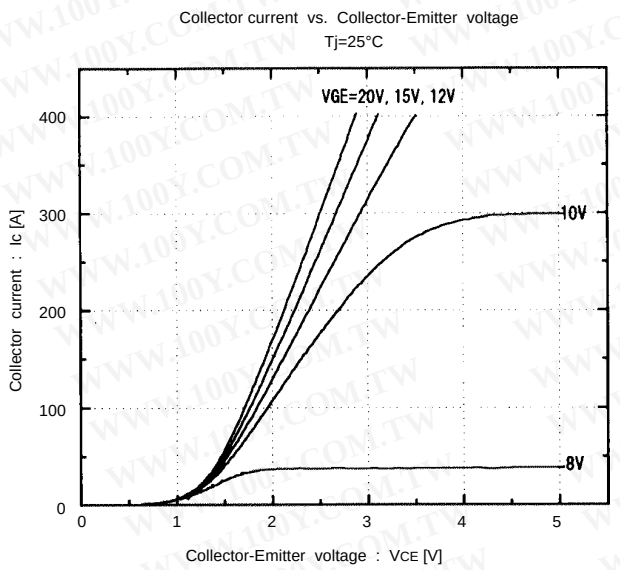
*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound



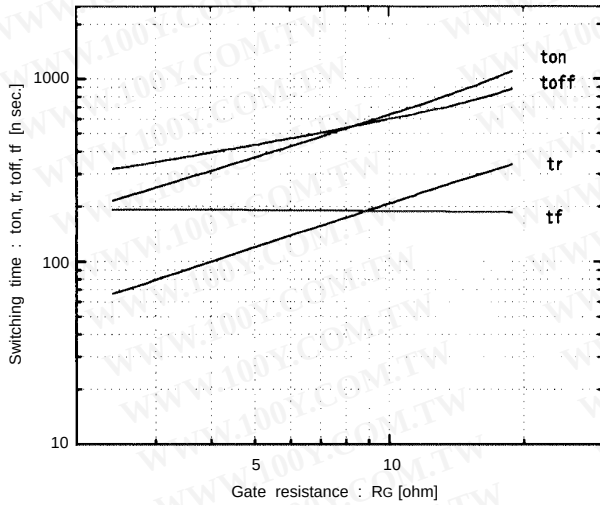
Equivalent Circuit Schematic



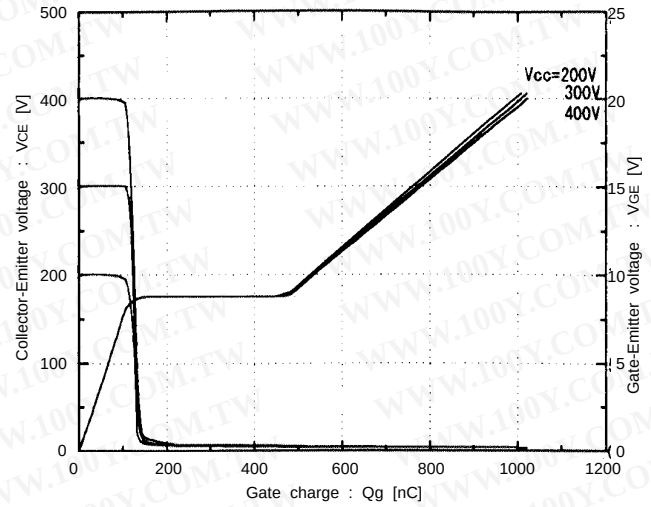
Characteristics (Representative)



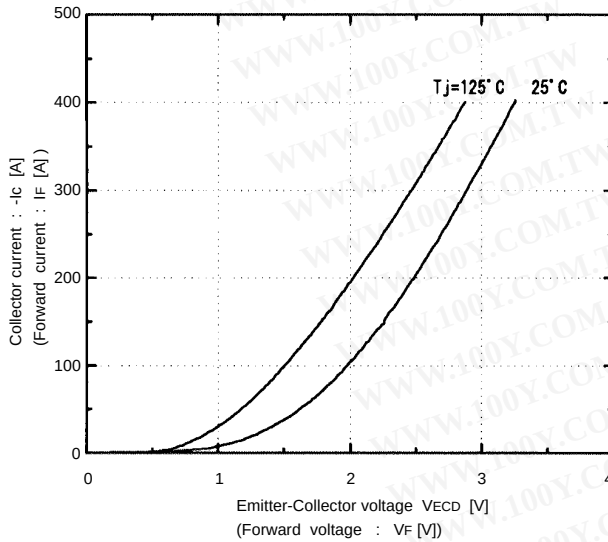
Switching time vs. R_G
 $V_{CC}=300V$, $I_C=200A$, $V_{GE}=\pm 15V$, $T_J=25^\circ C$



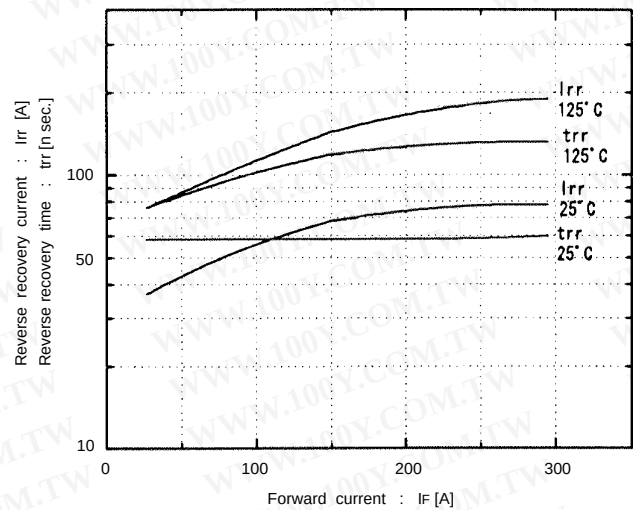
Dynamic input characteristics
 $T_J=25^\circ C$



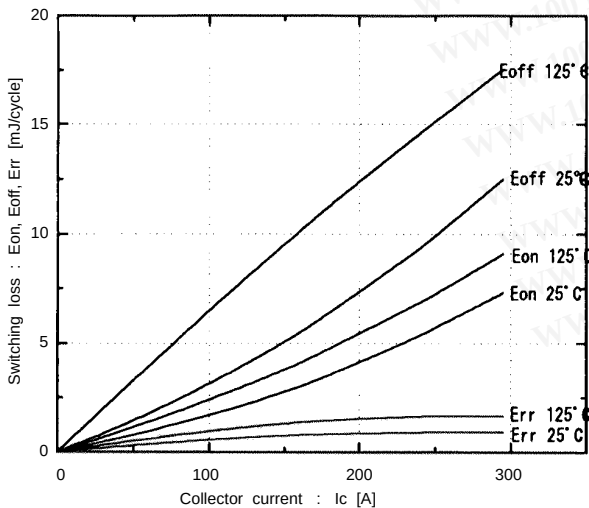
Forward current vs. Forward voltage
 $V_{GE}=0V$



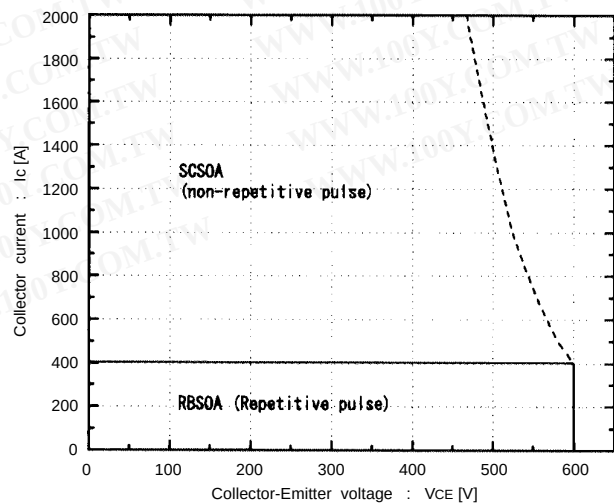
Reverse recovery characteristics
 t_{rr} , I_{rr} , vs. I_F

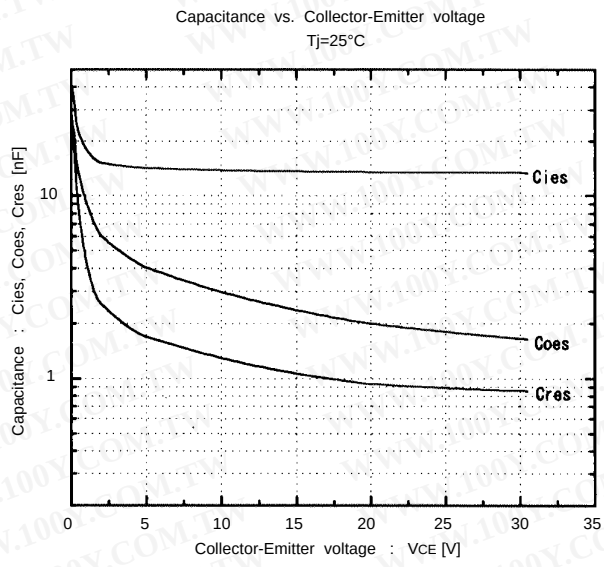
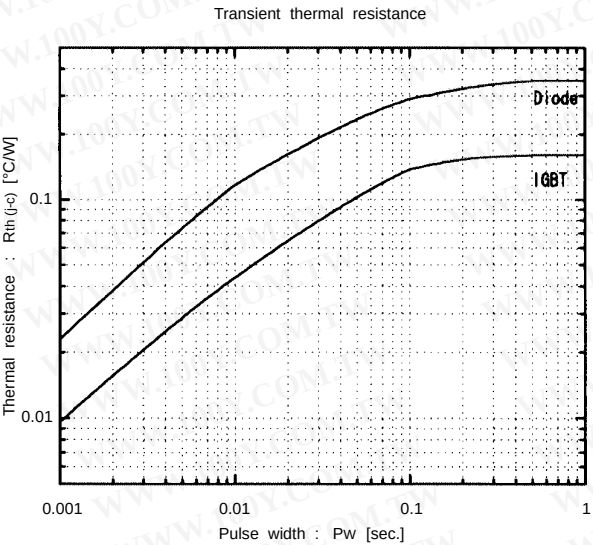


Switching loss vs. Collector current
 $V_{CC}=300V$, $R_G=9.1$ ohm, $V_{GE}=\pm 15V$



Reversed biased safe operating area
 $+V_{GE}=15V$, $-V_{GE} \leq 15V$, $T_J \leq 125^\circ C$, $R_G \geq 9.1$ ohm





■ Outline Drawings, mm

